Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	76	(@ad<"20000428") and (wafer same (encapsulant or encapsualte)) and (dice or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:22
L5	492	(@ad<"20000428") and (wafer same (encapsulant or encapsulate or epoxy)) and (dice or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:37
L7	416	L5 not L4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:34
L8	18	("6133634").URPN.	USPAT	OR	OFF	2005/02/09 09:27
L9	0	("6420212").URPN.	USPAT	OR	OFF	2005/02/09 09:29
L10	6	("5496775" "6023094" "6075290" "6133634" "6204095" "6245595").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/02/09 09:29
L11	10	("3212160" "4600600" "4807021" "4899107" "5071787" "5143865" "5289346" "5341564" "5348607").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/02/09 09:31
L12	38	("5496775").URPN.	USPAT	OR	OFF	2005/02/09 09:31
L13	416	L5 not L4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:34
L14	810	(@ad<"20000428") and ((cihp or die) same (encapsulant or encapsulate or epoxy)) and (csp or scale) and (solder or ball or bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:38
L15	524	(@ad<"20000428") and ((chip or die) same (encapsulant or encapsulate or epoxy)) and (csp or (chip adj scale)) and (solder or ball or bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:39

L16	507	L15 not L13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:39
S1	12	(("5942579") or ("6518662") or ("5956236") or ("6373133") or ("5600181") or ("5796164") or ("4931853") or ("6104089") or ("6242283") or ("5786628") or ("6445591") or ("5874774")).PN.	USPAT	OR	OFF	2005/02/08 09:37
S2	76	(@ad<"20000428") and (wafer same (encapsulant or encapsualte)) and (dice or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/08 09:57
S3	10	("5837566" "5872025" "5952725" "5953589" "5963792" "6103548" "6111220" "6133065" "6210992" "6238949").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/02/08 09:40
S4	9	("63 444 01").URPN.	USPAT	OR	OFF	2005/02/08 09:47
S5	1	("6344401").PN.	USPAT	OR	OFF	2005/02/08 09:47
S6	10	("5837566" "5872025" "5952725" "5953589" "5963792" "6103548" "6111220" "6133065" "6210992" "6238949").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/02/08 09:50
S7	36	("5950070").URPN.	USPAT	OR	OFF	2005/02/08 09:53
S8	492	(@ad<"20000428") and (wafer same (encapsulant or encapsulate or epoxy)) and (dice or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/08 09:57
S9	416	S8 not S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/09 09:22
S10	6	("6294403").URPN.	USPAT	OR	OFF	2005/02/08 10:01
S11	1	("5466966").PN.	USPAT	OR	OFF	2005/02/08 12:06
S12	1	("20030042581").PN.	US-PGPUB; USPAT	OR	OFF	2005/02/08 12:23
S13	1	("20020074690").PN.	US-PGPUB; USPAT	OR	OFF	2005/02/08 12:33

S14	3	(("6111315") or ("6331453") or ("6560122")).PN.	US-PGPUB; USPAT	OR	OFF	2005/02/08 12:53
S15		("5239447").PN.	031.01.00,	OR	OFF	2005/02/08 14:03
S16	1	("6418033").PN.	US-PGPUB; USPAT	OR	OFF	2005/02/08 14:06